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Vishay Semiconductors

High Performance Schottky Rectifier, 2 x 20 A

Base common cathode Ca

VS-40CTQ045SPbF

cathode Anode

Anode

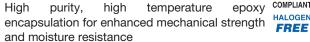
VS-40CTQ045-1PbF

cathode Anode

PRODUCT SUMMARY	
Package	TO-263AB (D ² PAK), TO-262AA
I _{F(AV)}	2 x 20 A
V _R	45 V
V _F at I _F	0.48 V
I _{RM} max.	115 mA at 125°C
T _J max.	150 °C
Diode variation	Common cathode
E _{AS}	20

FEATURES

- 150 °C T_J operation
- Center tap configuration
- · Very low forward voltage drop
- High frequency operation





- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

This center tap Schottky rectifier has been optimized for very low forward voltage drop, with moderate leakage. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{F(AV)}	Rectangular waveform	40	A			
V _{RRM}		45	V			
I _{FSM}	t _p = 5 μs sine	1240	A			
V _F	20 A _{pk} , T _J = 125 °C (per leg)	0.48	V			
T _J	Range	-55 to +150	°C			

VOLTAGE RATINGS					
PARAMETER	SYMBOL	VS-40CTQ045SPbF VS-40CTQ045-1PbF	UNITS		
Maximum DC reverse voltage	V_{R}	45	V		
Maximum working peak reverse voltage	V_{RWM}	45	V		

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST COND	ITIONS	VALUES	UNITS
Maximum average forward per leg	1	I _{F(AV)} 50 % duty cycle at T _C = 116 °C, rectangular waveform		20	
current, see fig. 5 per device	IF(AV)			40	
Maximum peak one cycle non-repetitive		5 μs sine or 3 μs rect. pulse	Following any rated load	1240	Α
surge current per leg, see fig. 7	I _{FSM}	10 ms sine or 6 ms rect. pulse	condition and with rated V _{RRM} applied	350	
Non-repetitive avalanche energy per leg	E _{AS}	$T_J = 25 ^{\circ}\text{C}, I_{AS} = 3 \text{A}, L = 4.40 \text{mHz}$	Н	20	mJ
Repetitive avalanche current per leg	I _{AR}	Current decaying linearly to zero Frequency limited by T_J maximum		3	А

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VS-40CTQ045SPbF, VS-40CTQ045-1PbF

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ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS
		20 A	T _{.1} = 25 °C	0.53	V
Maximum forward voltage drop per leg See fig. 1	V _{FM} ⁽¹⁾	40 A	1J=25 C	0.68	
	VFM (")	20 A	T _J = 125 °C	0.48	
		40 A	1 1j = 125 C	0.67	
Maximum reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C	V Dated V	3	- mA
See fig. 2	IRM ("/	T _J = 125 °C	V _R = Rated V _R	115	
Threshold voltage	V _{F(TO)}	T T massimum		0.27	V
Forward slope resistance	r _t	$T_J = T_J$ maximum		8.72	mΩ
Maximum junction capacitance per leg	C _T	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz), 25 °C		2800	pF
Typical series inductance per leg	L _S	Measured lead to lead 5 r	mm from package body	8.0	nH
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs

Note

 $^{^{(1)}\,}$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL TEST CONDITIONS		VALUES	UNITS	
Maximum junction and storage temperature range		T _J , T _{Stg}		-55 to +150	°C	
Maximum thermal resistance, junction to case per leg Maximum thermal resistance, junction to case per package		D				
		R _{thJC} DC operation		1.0	°C/W	
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.50		
Annyayimata wajaht				2	g	
Approximate weight				0.07	OZ.	
Manustinastaurus	minimum			6 (5)	kgf ⋅ cm	
Mounting torque	maximum			12 (10)	(lbf \cdot in)	
			Case style TO-263AB (D2PAK)	40CT0	Q045S	
Marking device			Case style TO-262AA	40CTC	045-1	

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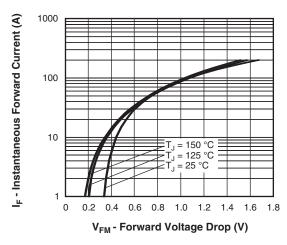


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

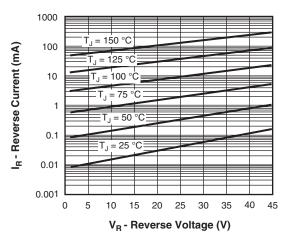


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

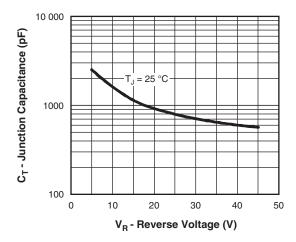


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

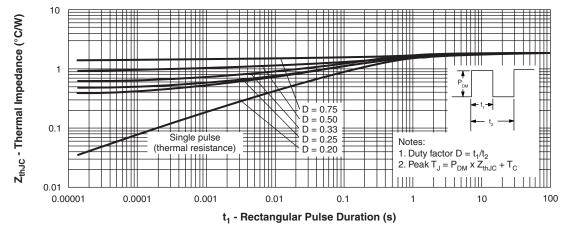


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)

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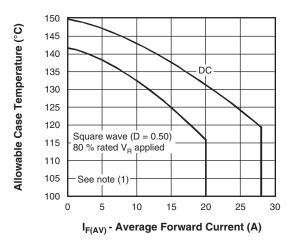


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

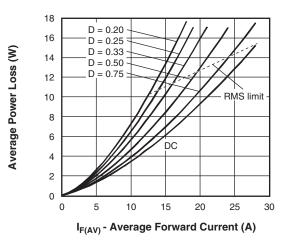


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

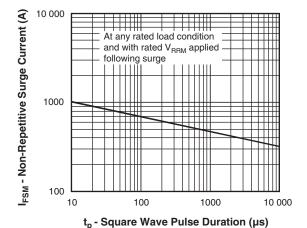


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

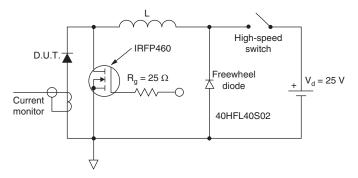


Fig. 8 - Unclamped Inductive Test Circuit

Note

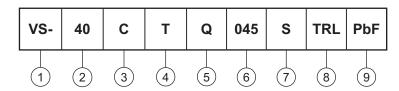
 $^{(1)}$ Formula used: $T_C = T_J$ - (Pd + Pd_{REV}) x R_{thJC}; Pd = Forward power loss = $I_{F(AV)}$ x V_{FM} at (I_{F(AV)}/D) (see fig. 6); Pd_{REV} = Inverse power loss = V_{R1} x I_R (1 - D); I_R at V_{R1} = 10 V

VS-40CTQ045SPbF, VS-40CTQ045-1PbF

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ORDERING INFORMATION TABLE

Device code



- Vishay Semiconductors product

2 - Current rating (40 A)

Circuit configuration: C = common cathode

4 - T = TO-220

5 - Schottky "Q" series

6 - Voltage rating (045 = 45 V)

7 - • S = D²PAK

• -1 = TO-262

8 - • None = tube (50 pieces)

• TRL = tape and reel (left oriented - for D²PAK only)

• TRR = tape and reel (right oriented - for D²PAK only)

9 - PbF = lead (Pb)-free

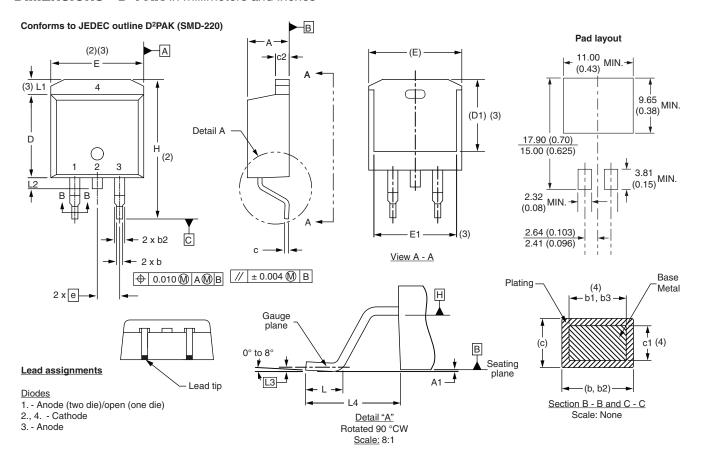
ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER REEL	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-40CTQ045SPBF	50	1000	Antistatic plastic tubes			
VS-40CTQ045STRRPBF	800	800	13" diameter plastic tape and reel			
VS-40CTQ045STRLPBF	800	800	13" diameter plastic tape and reel			
VS-40CTQ045-1PBF	50	1000	Antistatic plastic tubes			

LINKS TO RELATED DOCUMENTS				
TO-263AB (D ² PAK) <u>www.vishay.com/doc?95046</u>				
Dimensions	TO-262AA	www.vishay.com/doc?95419		
Part marking information		www.vishay.com/doc?95008		
Packaging information		www.vishay.com/doc?95032		

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D²**PAK**, **TO**-262

DIMENSIONS - D²PAK in millimeters and inches



SYMBOL	MILLIMETERS INCHES		NOTES		
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIMETERS		INCHES		NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
Е	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		3SC 0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010	BSC	·
L4	4.78	5.28	0.188	0.208	·

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- $^{(3)}$ Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch

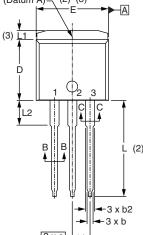
(7) Outline conforms to JEDEC outline TO-263AB

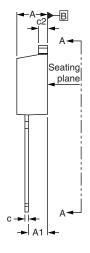
Document Number: 95014 Revision: 31-Mar-09

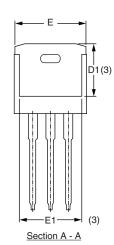


DIMENSIONS - TO-262 in millimeters and inches

Modified JEDEC outline TO-262 (Datum A) - (2) (3)







⊕ 0.010 **M** A **M** B

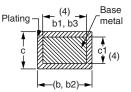
Lead assignments



Diodes

1. - Anode (two die)/open (one die) 2., 4. - Cathode

3. - Anode



Section B - B and C - C Scale: None

CYMPOL	MILLIM	ETERS	INC	HES	NOTES
SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2 1.	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
Е	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54	BSC	0.100) BSC	
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.56	3.71	0.140	0.146	

Notes

- $^{(1)}$ Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches

(6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline



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